## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date	
Hwi Tae Lim	12/21/2009	
Seong Jae Lim	12/21/2009	

#### **RECEIVING PARTY DATA**

Name:	LG Electronics Inc.
Street Address:	20 Yeouido-dong, Yeongdeungpo-gu
City:	Seoul
State/Country:	REPUBLIC OF KOREA
Postal Code:	150-721

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	29352893

## **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER: 001082-7002

NAME OF SUBMITTER: Robert J. Goodell

Total Attachments: 1

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PATENT REEL: 023713 FRAME: 0956 CH \$40.00

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ATTORNEY DOCKET NO.: - SOLE/JOINT INVENTION (U.S. Rights Only)

# ASSIGNMENT

WHEREAS I/We, the below named inventor(s),	, [hereinafter	referred to	o as Assigno	r(s)], have
made an invention entitled:	-		O	( )1)

MOBILE PHONE				
for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on, (Application No); and				
WHEREAS, LG Electronics Inc., a corporation of Republic of Korea, whose post office address is 20, Yeouido-dong, Yeongdeungpo-gu, Seoul, Korea 150-721, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;				
NOW THEREFORE, be it known that from assignee is hereby acknowledged, I/WE, and do hereby sell, assign, transfer, and set ove MY/OUR entire right, title, and interest in and continuations thereof, and all Letters Patent of reissues thereof; and I/WE hereby authorize an the United States to issue all Letters Patent for accordance with the terms of this Assignment;	er unto the assignee, its lawful successors to this invention and this application, and the United States which may be granted t d request the Commissioner of Patents an	erred, and set over, and assigns, I all divisions, and hereon, and all Id Trademarks of		
AND, I/WE HEREBY further covenant communicate with assignee, its successors and invention and testify in any legal proceeding, si and deliver all papers that may be necessary or assignee, its successors and assigns, execute all all rightful oaths and generally do everything peand enforce proper patent protection for this invexpense incident to the execution of such paper	gn all lawful papers when called upon to desirable to perfect the title to this invent divisional, continuation, and reissue applossible to aid assignee, its successors and vention in the United States, it being under	ecting this do so, execute ion in said lications, make assigns, to obtain		
AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No, filed) the filing date and application number of said application when known.				
IN TESTIMONY WHEREOF, I/WE ha				
Full Name of Sole or First Assignor LIM, Hwi Tac	Assignor's Signature	Date December 21, 2009		
Address 303 Ho, 265-80, Hongeun-3-dong, Seodaemun-ku, Seoul, Korca	1 1 m, 1141 100	Citizenship Republic of Korea		
Full Name of Second Assignor LIM, Seong Jae	Assignor's Signature Lim, Seong Jue	Date December 21, 2009		
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Names of additional inventors attached Yes	⊠ No			

**RECORDED: 12/29/2009** 

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